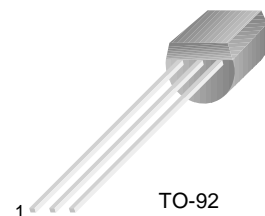


PN3646

PN3646

NPN Switching Transistor

- Sourced from process 22.



TO-92
1. Emitter 2. Base 3. Collector

Absolute Maximum Ratings * $T_a=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Value | Units |
|-----------|--|------------|------------------|
| V_{CEO} | Collector-Emitter Voltage | 15 | V |
| V_{CBO} | Collector-Base Voltage | 40 | V |
| V_{EBO} | Emitter-Base Voltage | 5.0 | V |
| I_C | Collector Current - Continued | 300 | mA |
| T_{STG} | Operating and Storage Junction Temperature Range | - 55 ~ 150 | $^\circ\text{C}$ |

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired

NOTES:

- These ratings are based on a maximum junction temperature of 150 degrees C.
- These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Electrical Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|-------------------------------------|---------------------------------------|---|----------------|--------------------|--------------------------------|
| Off Characteristics | | | | | |
| $BV_{(BR)CEO}$ | Collector-Emitter Breakdown Voltage * | $I_C = 10\text{mA}, I_B = 0$ | 15 | | V |
| $BV_{(BR)CES}$ | Collector-Emitter Breakdown Voltage | $I_C = 100\mu\text{A}, V_{BE} = 0$ | 40 | | V |
| $BV_{(BR)CBO}$ | Collector-Base Breakdown Voltage | $I_C = 100\mu\text{A}, I_E = 0$ | 40 | | V |
| $BV_{(BR)EBO}$ | Emitter-Base Breakdown Voltage | $I_E = 100\mu\text{A}, I_C = 0$ | 5.0 | | V |
| I_{CES} | Collector Cutoff Current | $V_{CE} = 20\text{V}, V_{BE} = 0$ $V_{CE} = 20\text{V}, V_{BE} = 0, T_a = 65^\circ\text{C}$ | | 0.5 3.0 | μA μA |
| On Characteristics * | | | | | |
| h_{FE} | DC Current Gain | $V_{CE} = 0.4\text{V}, I_C = 30\text{mA}$ $V_{CE} = 0.5\text{V}, I_C = 100\text{mA}$ $V_{CE} = 1.0\text{V}, I_C = 300\text{mA}$ | 30 25 15 | 120 | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = 30\text{mA}, I_B = 3.0\text{mA}$ $I_C = 100\text{mA}, I_B = 10\text{mA}$ $I_C = 300\text{mA}, I_B = 3.0\text{mA}$ | | 0.2 0.28 0.5 | V V V |
| $V_{BE(sat)}$ | Base-Emitter Saturation Voltage | $I_C = 30\text{mA}, I_B = 3.0\text{mA}$ $I_C = 100\text{mA}, I_B = 10\text{mA}$ $I_C = 300\text{mA}, I_B = 3.0\text{mA}$ | 0.73 | 0.95 1.2 1.7 | V V V |
| Small Signal Characteristics | | | | | |
| C_{cb} | Collector-Base Capacitance | $V_{CB} = 5.0\text{V}, I_E = 0, f = 1\text{MHz}$ | | 5.0 | pF |
| C_{eb} | Emitter-Base Capacitance | $V_{CB} = 5.0\text{V}, I_C = 0, f = 1\text{MHz}$ | | 8.0 | pF |
| h_{fe} | Small-Signal Current Gain | $I_C = 300\text{mA}, V_{CE} = 10\text{V}, f = 100\text{MHz}$ | 3.5 | | |

* Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2.0\%$

Electrical Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted (Continued)

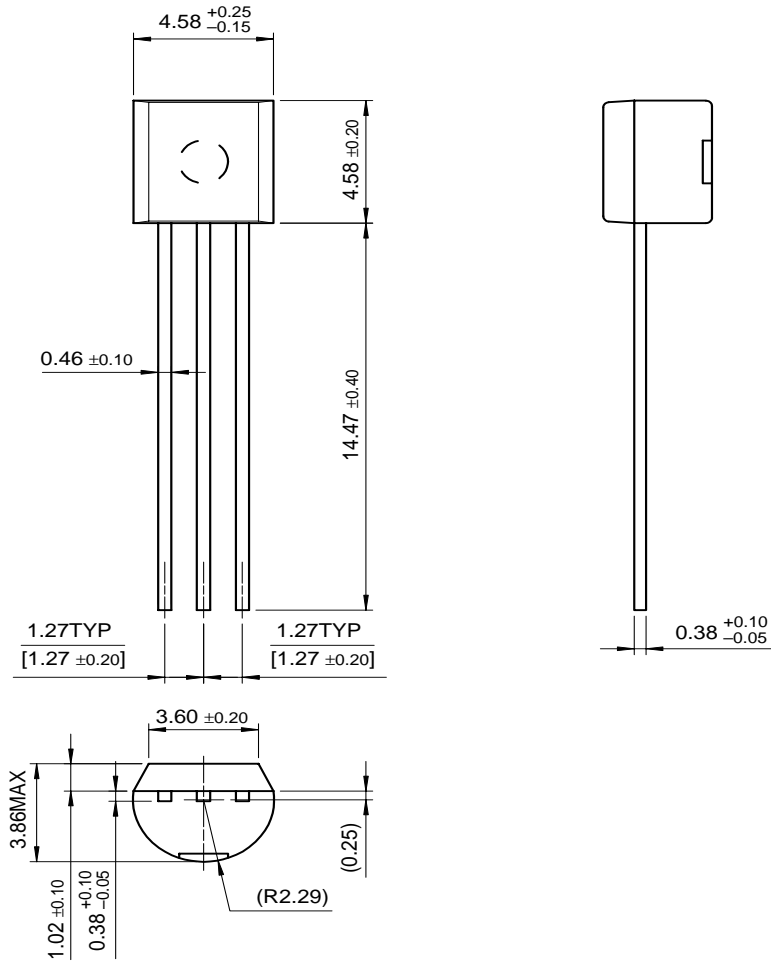
| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|----------------------------------|---------------|---|------|------|-------|
| Switching Characteristics | | | | | |
| t_s | Storage Time | $I_C = 300\text{mA}$, $V_{CC} = 10\text{V}$ $I_{B1} = I_{B2} = 30\text{mA}$ | | 20 | ns |
| t_{on} | Turn-On Time | | | 18 | ns |
| t_{off} | Turn-Off Time | | | 28 | ns |

Thermal Characteristics $T_a=25^\circ\text{C}$ unless otherwise noted

| Symbol | Parameter | Max. | Units |
|-----------------|---|------|----------------------|
| P_D | Total Device Dissipation | 350 | mW |
| | Derate above 25°C | 2.8 | mW/ $^\circ\text{C}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 357 | $^\circ\text{C/W}$ |

Package Dimensions

TO-92



Dimensions in Millimeters

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|--------------------------|------------------------|---|
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